PTO-1449 REPRODUCED PERFORMATION DISCLOSURE CITATION IN AN APPLICATION	ATTORNEY DOCKET NO. 2678.2011-000		
	FIRST NAMED INVENTOR Premakaran T. Boaz		FILING DATE March 17, 2004
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No.	THAUEN	<u> </u>	S. PATENT DOCUMENTS	
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EXAM- INER INI- TIAL	REF. NO.	DOCUMENT NUMBER Number-Kind Code (if known)	ISSUE DATE / PUBLICATION DATE MM-DD-YYYY	NAME OF PATENTEE OR APPLICANT OF CITED DOCUMENT
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PTO-1449 REPRODUCED	ATTORNEY DOCKET NO. 2678.2011-000	APPLICATION NO. 10/802,387		
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EXAMINER 5. To	DATE CONSIDERED 3/24/07